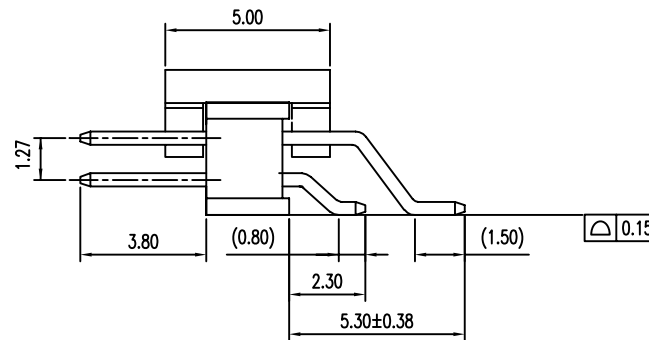


Recommended P.C.B. Layout
Layout Tolerance = ± 0.05 mm



NOTE:

- MATERIAL,
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY, SQ=0.40±0.03MM
- FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1um(40u") MIN Ni OVER ALL
- SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
- THE HSG. WILL WITHSTAND EXPOSURE TO 260°C
PEAK TEMP. FOR 10 SEC. IN A CONVECTION INFRA-RED
OR VAPOR PHASE REFLOW OVEN.
- THE TOLERANCE OF THIS DIMENSION

2-60 PINS	± 0.20
62-98 PINS	± 0.30

- PRODUCT NUMBERING:
20021122 - 0 0 0 XX X X LF

LEAD FREE
PLATING:
1: GOLD FLASH ALL OVER
4: 0.25um(10U") GOLD AT CONTACT
8: 0.76um(30U") GOLD AT CONTACT
9: 1u" GOLD OVER 30u" PdNi AT CONTACT
PACKING
T: TUBE
D: TUBE + CAP
C: REEL + CAP
PIN COUNT
06, 08, 10, ..., 98
(8 - 98 EVERY EVEN PIN)

mat'l. code		surface		tolerance		projection		product family			
		ISO1302	ISO1101	ISO406	MM		MINITEK				
ltr	ecn no	dr	date	tolerances unless otherwise specified		MM		title			
A	T09-1117	S.LIN	09/15/09	angles	0.X±0.38	MM		1.27X1.27MM BTB HEADER			
B	T09-1155	S.LIN	12/03/09	0°±2'	0.XX±0.25	MM		UNSHROUDED SMT			
C	T10-0014	S.LIN	01/28/10	0°±2'	0.XXX±0.10	scale 5:1		sheet. 1 of 1 size			
D	T11-0029	S.LIN	06/14/11	dr	STERLING LIN	09/15/09	FCI		20021122		
E	ELX-N-010358	ZK	01/16/12	engr	STERLING LIN	09/15/09	type		Product Customer Drawing		
F	ELX-N-010619	ZK	03/12/12	chr	GRAY HSIEH	09/15/09					
G	ELX-N-16465	TIM	12/06/13	appd	JOSEPH	09/15/09					
sheet	revision	G									
index	sheet	1									